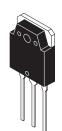
# **WPB4002**

# **N-Channel Power MOSFET** 600V, 23A, 0.36Ω, TO-3P-3L



#### ON Semiconductor®

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TO-3P-3L

#### **Features**

- Reverse recovery time t<sub>rr</sub>=115ns (typ)
- Input capacitance Ciss=2200pF (typ)
- ON-resistance RDS(on)= $0.28\Omega$  (typ)

#### **Specifications**

#### Absolute Maximum Ratings at Ta=25°C

3				
Parameter	Symbol	Conditions	Ratings	Unit
Drain to Source Voltage	VDSS		600	V
Gate to Source Voltage	V <sub>GSS</sub>		±30	V
Drain Current (DC)	ID		23	А
Drain Current (Pulse)	IDP	PW≤10μs, duty cycle≤1%	80	А
Source to Drain Diode Forward Current (DC)	ISD		23	Α
Source to Drain Diode Forward Current (Pulse)	ISDP	PW≤10μs, duty cycle≤1%	80	А
Allowable Power Dissipation	PD		2.5	W
		Tc=25°C	220	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C
Avalanche Energy (Single Pulse) *1	EAS		157	mJ
Avalanche Current *2	I <sub>AV</sub>		17	Α

• 10V drive

Note :\*1  $V_{DD}$ =50V, L=1mH,  $I_{AV}$ =17A (Fig.1)

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

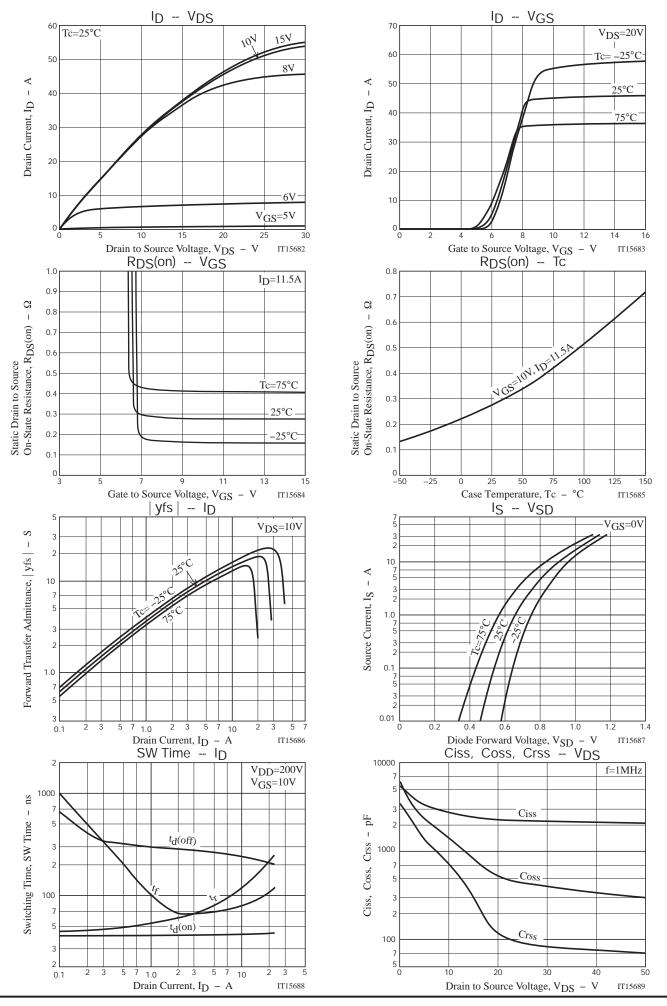
#### Electrical Characteristics at Ta=25°C

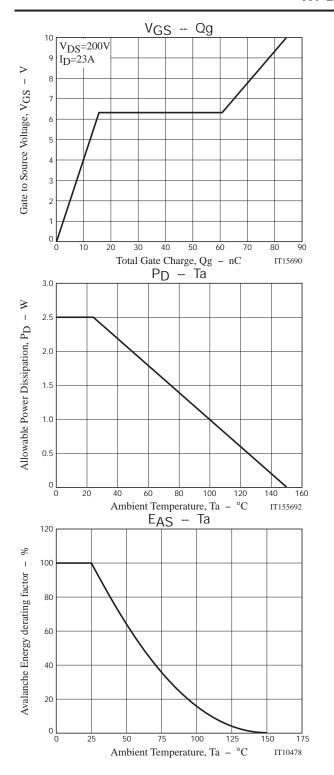
Parameter	Symbol	Conditions	Ratings			11.21
			min	typ	max	Unit
Drain to Source Breakdown Voltage	V(BR)DSS	ID=10mA, VGS=0V	600			V
Zero-Gate Voltage Drain Current	IDSS	V <sub>DS</sub> =480V, V <sub>GS</sub> =0V			100	μΑ
Gate to Source Leakage Current	IGSS	V <sub>GS</sub> =±30V, V <sub>DS</sub> =0V			±100	nA
Cutoff Voltage	VGS(off)	V <sub>DS</sub> =10V, I <sub>D</sub> =1mA	3		5	V
Forward Transfer Admittance	yfs	V <sub>DS</sub> =10V, I <sub>D</sub> =11.5A	7.5	15		S
Static Drain to Source On-State Resistance	R <sub>DS</sub> (on)	I <sub>D</sub> =11.5A, V <sub>G</sub> S=10V		0.28	0.36	Ω
Input Capacitance	Ciss	V <sub>DS</sub> =30V, f=1MHz		2200		pF
Output Capacitance	Coss			400		pF
Reverse Transfer Capacitance	Crss			83		pF
Turn-ON Delay Time	t <sub>d</sub> (on)	See Fig.2		42		ns
Rise Time	t <sub>r</sub>			130		ns
Turn-OFF Delay Time	t <sub>d</sub> (off)			234		ns
Fall Time	tf			84		ns
Total Gate Charge	Qg	V <sub>DS</sub> =200V, V <sub>GS</sub> =10V, I <sub>D</sub> =23A		84		nC
Gate to Source Charge	Qgs			15.2		nC
Gate to Drain "Miller" Charge	Qgd			45.4		nC
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =23A, V <sub>GS</sub> =0V		1.1	1.5	V
Reverse Recovery Time	t <sub>rr</sub>	See Fig.3		115		ns
Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>SD</sub> =23A, V <sub>GS</sub> =0V, di/dt=100A/μs		340		nC

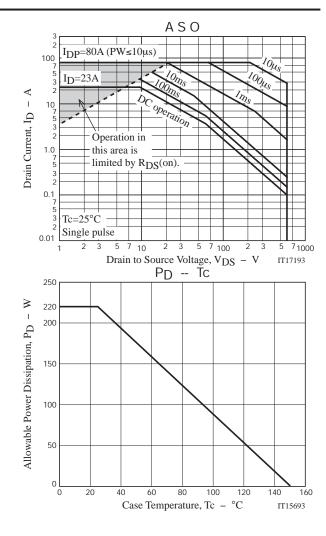
#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 4 of this data sheet.

<sup>\*2</sup> L≤1mH, single pulse







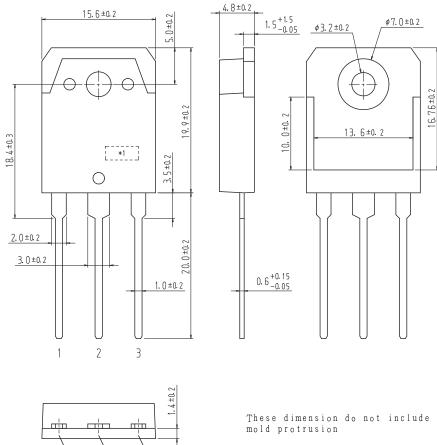
#### **Package Dimensions**

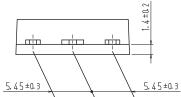
WPB4002-1E

TO-3P-3L CASE 340AF ISSUE O

Unit : mm

- 1: Gate
- 2: Drain
- 3: Source





\*1:Lot indication

#### **Ordering & Package Information**

Device	Package	Shipping	memo
WPB4002-1E	TO-3P-3L SC-65, SOT-199, TO-247	30 pcs./tube	Pb-Free

### Marking



## **Electrical Connection**

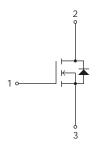
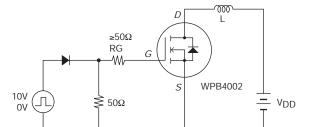


Fig.1 Unclamped Inductive Switching Test Circuit



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Fig.2 Switching Time Test Circuit

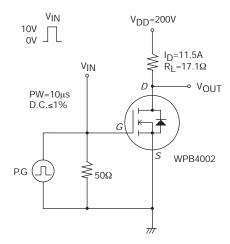
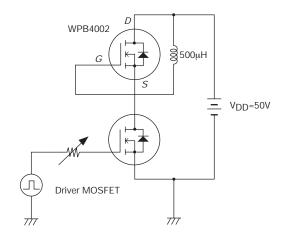


Fig.3 Reverse Recovery Resistance Test Circuit

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Note on usage: Since the WPB4002 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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